An experimentally-validated multi-scale materials, process and device modelling & design platform enabling non-expert access to open innovation in the Organic and Large Area Electronics Industry (MUSICODE)

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Validation of modelling gas phase processing in OE materials

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Dissemination Level		
PU	Public	
PP	Restricted to other programme participants (including the Commission Service)	
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Publishable summary

The MUSICODE modelling platform is used to simulate a gas phase deposition system and processes to fabricate organic electronic material layers. The organic material is transported in a heated inert gas stream through the hot deposition system under vacuum conditions and gets deposited uniformly on a cold substrate. Computational Fluid Dynamics and Molecular Dynamics Calculations are used to try to match the experimental molecular deposition of the gas phase deposition process.